1. [HIR Annual Workshop & Symposium](https://r6.ieee.org/scv-eps/?p=2865), February 21-23, 2024
2. IMAPS Device Packaging Conference Arizona, March 18 – 21, 2024
3. [EuroSimE](https://www.eurosime.org/)  Sicily, Italy April 7-10, 2024
4. [ECTC](http://ectc.net/) & [ITherm](https://www.ieee-itherm.net/itherm/conference/home) Denver, CO May 28 – 31, 2024
5. [SEMICON West](https://www.semiconwest.org/) San Francisco, CA July 9 – 11, 2024
6. [Electronics Packaging Symposium](https://www.binghamton.edu/ieec/eps/index.html) Binghamton, NY Sept 4-5, 2024
7. [ESTC](https://www.estc-conference.net/home) Berlin, Germany Sept 11 – 13, 2024
8. [SEMICON Taiwan](https://www.semicontaiwan.org/en) Taipei, Taiwan, Sept 4- 6, 2024
9. [IMAPS](https://www.imaps.org/imaps_symposium_2022_boston.php) Boston, MA, Oct 2024
10. [EPEPS](https://attend.ieee.org/epeps-2024/) Toronto, Canada Oct 6 – 9, 2024
11. [InterPACK](https://event.asme.org/InterPACK) San Jose, CA Oct 8 – 10, 2024
12. [EPTC](https://www.eptc-ieee.net/), Singapore, Dec 2024